



Ultra Fast Recovery Rectifier

VOLTAGE- 50 to 1000 Volts CURRENT - 3.0 Amperes



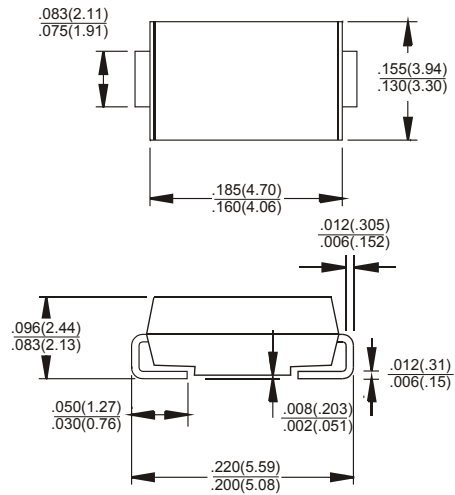
FEATURES

- Glass passivated chip
- Ultra fast switching for high efficiency
- For surface mounted applications
- Low forward voltage drop and high current capability
- Low reverse leakage current
- Plastic material has UL flammability classification 94V-0
- High temperature soldering : 260°C / 10 seconds at terminals
- Pb free product at available : 99% Sn above meet RoHS environment substance directive request

SMB/DO-214AA Unit:inch(mm)

MECHANICAL DATA

Case: JEDEC DO-214AA molded plastic
 Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
 Polarity: Indicated by cathode band
 Standard packaging: 12mm tape (EIA-481)



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%

CHARACTERISTICS	SYMBOL	UF3AB	UF3BB	UF3DB	UF3GB	UF3JB	UF3KB	UF3MB	UNIT
Maximum Recurrent Peak Reverse Voltage	VRRM	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @TL =75°C	I(AV)	3.0							A
Peak Forward Surge Current 8.3ms single half sine-wave super imposed on rated load (JEDEC METHOD)	IFSM	100							A
Maximum forward Voltage at 3.0A DC	VF	1.0		1.3	1.5	1.7		V	
Maximum DC Reverse Current @TJ =25°C at Rated DC Blocking Voltage @TJ =100°C	IR	10 100							uA
Maximum Reverse Recovery Time (Note 1)	TRR	50				75			ns
Typical Junction Capacitance (Note 2)	CJ	20				10			pF
Typical Thermal Resistance (Note 3)	RθJL	30							°C/W
Operating Temperature Range	TJ	-55 to +150							°C
Storage Temperature Range	TSTG	-55 to +150							°C

NOTES : 1.Reverse Recovery Test Conditions :IF=0.5A,IR=1.0A,IRR=0.25A.
 2.Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
 3.Thermal Resistance junction to Lead.

DEVICE CHARACTERISTICS

UF3AB THRU UF3MB

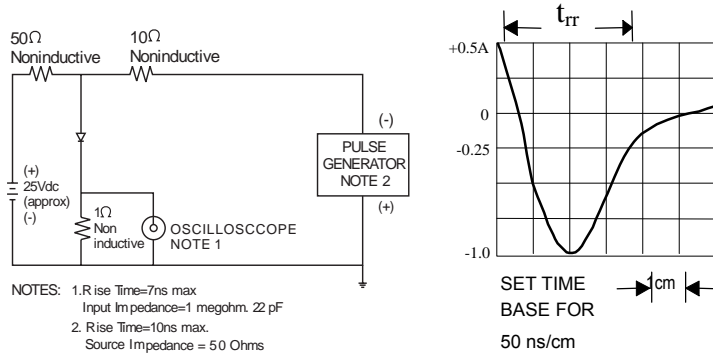


Fig. 1-REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM

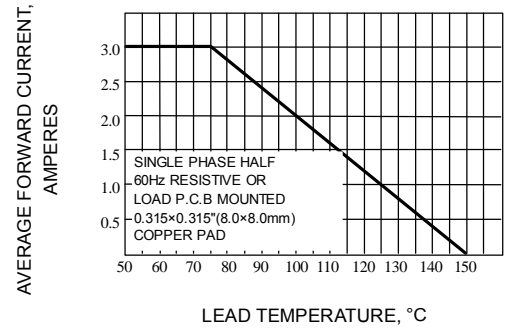


Fig. 2-MAXIMUM AVERAGE FORWARD CURRENT RATING

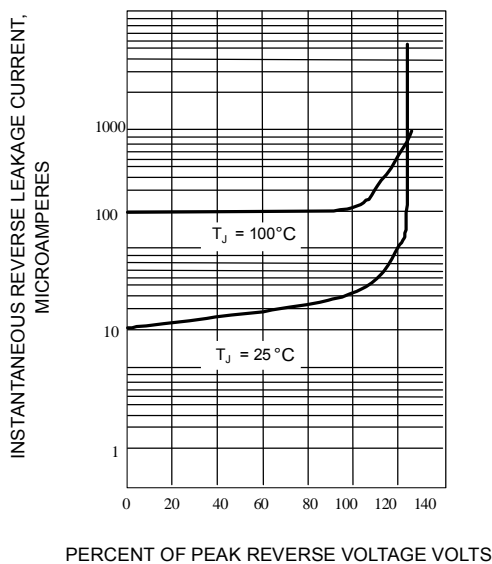


Fig. 3-TYPICAL REVERSE CHARACTERISTICS

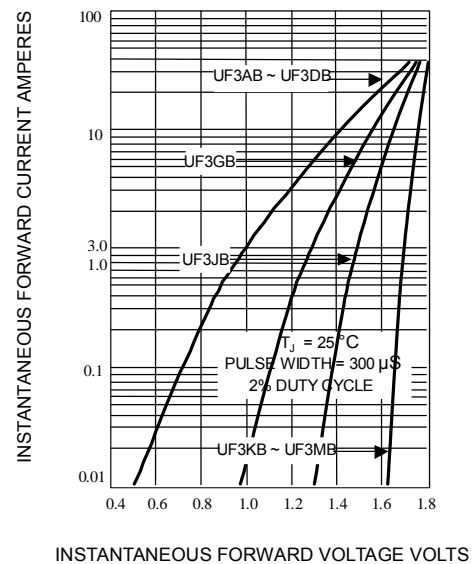


Fig. 4-TYPICAL FORWARD CHARACTERISTICS

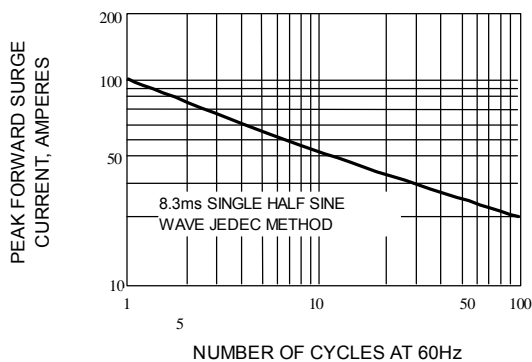


Fig. 5-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

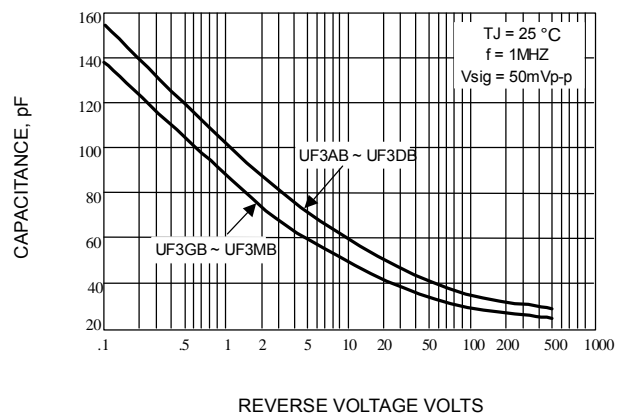


Fig. 6-TYPICAL JUNCTION CAPACITANCE